



LED

GooLED

GooLED-SAM-11080 Pin Fin LED Heat Sink Φ 110mm for Samsung

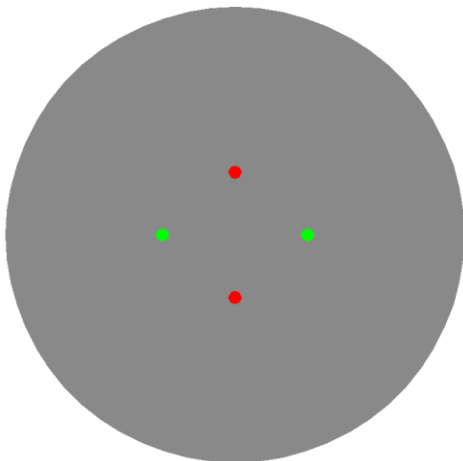
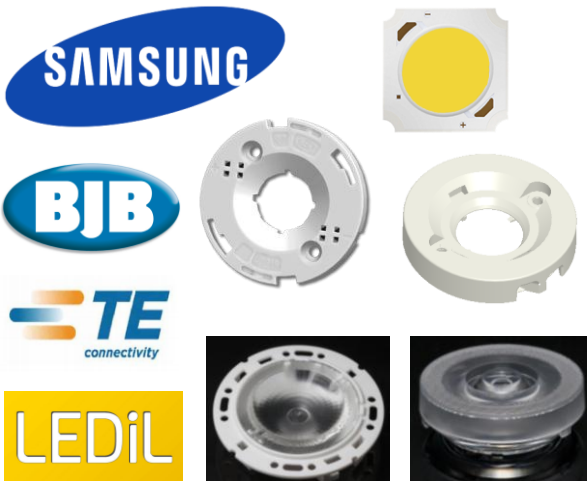
Features VS Benefits

- * The GooLED-SAM-11080 Samsung Pin Fin LED Heat Sinks are specifically designed for luminaires using the Samsung LED engines.
- * Mechanical compatibility with direct mounting of the LED engines to the LED cooler and thermal performance matching the lumen packages.
- * For spotlight and downlight designs from 2,500 to 7,000 lumen.
- * Thermal resistance range R_{th} 1.14°C/W.
- * Modular design with mounting holes foreseen for direct mounting of Samsung LED engines.
- * Diameter 110.0mm - standard height 80.0mm, Other heights on request.
- * Forged from highly conductive aluminum.



Zhaga LED engine and radiator assembly is a unified future international standardization

- * Below you find an overview of Samsung COB's and LED modules which standard fit on the Pin Fin LED Heat Sinks.
- * In this way mechanical after work and related costs can be avoided, and lighting designers can standardize their designs on a limited number of LED Pin Fin LED Heat Sink.



Samsung LED Modules directly Mounting Options

Samsung B Series LED modules name:

- L026B;
- L033B;
- L040B;

With the Zhaga Book 3 holders for the green indicator marks.
 BJB Holder: 47.319.2254.50;
 TE LED Holder: 2213258-1;
 Without the holders for the red indicator marks.
 Direct mounting with machine screws M3x6.5mm.

Samsung D Series LED modules name:

- LC016D;
- LC019D;
- LC026D;

With the Zhaga Book 3 holders for the green indicator marks.
 BJB Holder: 47.319.2021.50;
 TE LED Holder: 2213254-1;
 Direct mounting with machine screws M3x6.5mm.

With the LEDiL products:

- Ronda series: FN15xxx;
- Olivia series: FN14828-M; FN14637-S;

Samsung D Series LED modules name:

- LC040D;
- LC060D;

With the Zhaga Book 3 holders for the green indicator marks.
 BJB Holder: 47.319.2030.50;
 TE LED Holder: 2213480-1;
 Direct mounting with machine screws M3x6.5mm.

Samsung C Series LED modules name:

- LC040C;

With the Zhaga Book 3 holders for the green indicator marks.
 TE LED Holder: 2213382-1;
 Direct mounting with machine screws M3x6.5mm.
 With the LEDiL products:
 Ronda series: FN15xxx;

Mounting Options and Drawings & Dimensions

Example:GooLED-SAM-11080-B-1,2

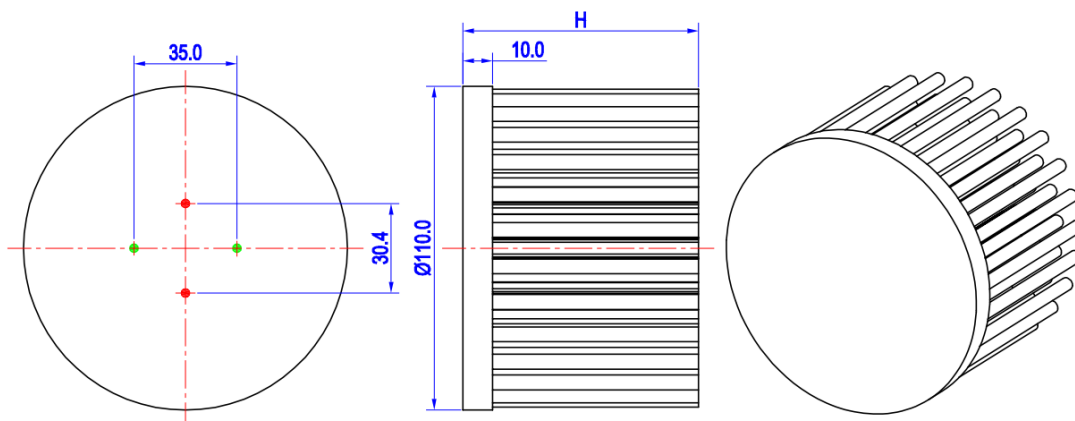
Example:GooLED-SAM-110 **1** - **2** - **3**

- 1** Height (mm)
- 2** Anodising Color
B-Black
C-Clear
Z-Custom
- 3** Mounting Options - see graphics for details Combinations available
Ex.order code - 12
means option 1 and 2 combined

Notes:

- Mentioned models are an extraction of full product range.
- For specific mechanical adaptations please contact MingfaTech.
- MingfaTech reserves the right to change products or specifications without prior notice.

MOUNTING OPTION	Module type	Holder NO.	LEDiL products		THREAD	THREAD DEPTH	THREAD HOLE DISTANCE
			Olivia series	Ronda series			
N	/	None	None	None	None	None	None
1		/			M3	6.5mm	30.4mm/ 2-@180°
2	L026B; L033B; L040B;	BJB Holder 47.319.2254.50 TE Holder 2213258-1	/		M3	6.5mm	35.0mm/ 2-@180° (Zhaga book 3)
	L016D; L018D; L026D;	BJB Holder 47.319.2021.50 TE Holder 2213254-1	FN14828-M; FN14637-S;	/			
	L040D; L060D;	BJB Holder 47.319.2030.50 TE Holder 2213480-1					
	L040C;	TE Holder 2213382-1	/	FN15xxx;			



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GooLED-SAM-11080 Pin Fin LED Heat Sink Φ 110mm for Samsung

The product data table

	Model No.	GooLED-SAM-11080
	Heatsink Size	Φ 110xH80mm
	Heatsink Material	AL1070
	Finish	Black Anodized
	Weight (g)	617.0
	Dissipated power (T_{hs-amb},50°C)	44.0 (W)
	Cooling surface area (mm²)	129119
	Thermal Resistance (R_{hs-amb})	1.14 (°C/W)

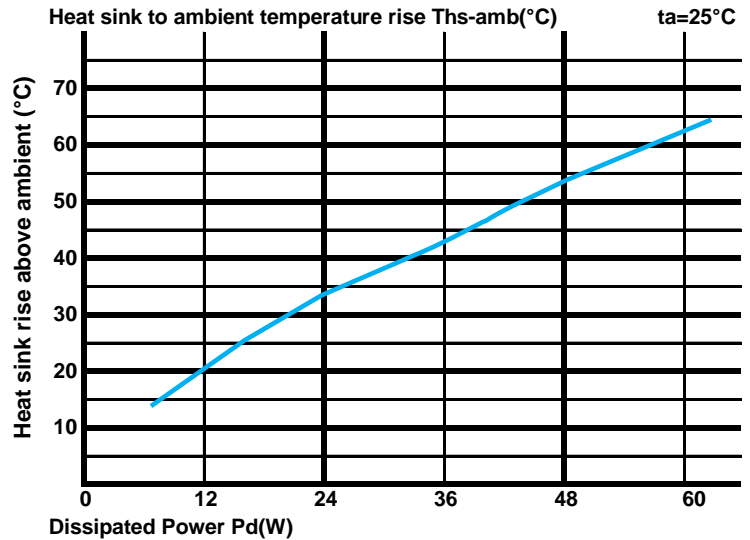
The thermal data table

* Please be aware the dissipated power Pd is not the same as the electrical power Pe of a LED module.

*To calculate the dissipated power please use the following formula: Pd = Pe x (1-ηL).

Pd - Dissipated power ; Pe - Electrical power ; ηL = Light efficiency of the LED module;

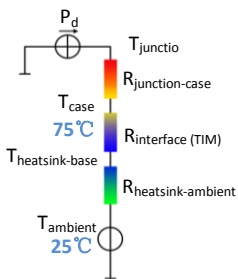
Dissipated Power Pd(W)	Pd = Pe x (1-ηL)	Heat sink to ambient thermal resistance R _{hs-amb} (°C/W)	Heat sink to ambient temperature rise T _{hs-amb} (°C)
		GooLED-SAM-11080	
12.0		1.67	20.0
24.0		1.38	33.0
36.0		1.17	42.0
48.0		1.10	53.0
60.0		1.03	62.0



*The aluminum substrate side of the package outer shell is thermally connected to the heat sink via TIM (Thermal interface material).

MingFa recommends the use of a high thermal conductive interface between the LED module and the LED cooler.

Either thermal grease, A thermal pad or a phase change thermal pad thickness 0.1-0.15mm is recommended.



*Thermal resistance is a heat property and a measurement of a temperature difference by which an object or material resists a heat flow.

Geometric shapes are different, the thermal resistance is different. Formula: $\theta = (T_{hs} - T_a) / P_d$

θ - Thermal Resistance [°C/W] ; T_{hs} - Heatsink temperature ; T_a - Ambient temperature ;

*The thermal resistance between the junction section of the light-emitting diode and the aluminum substrate side of the package outer shell is R_{junction-case}, the thermal resistance of the TIM outside the package is R_{interface (TIM)} [°C/W], the thermal resistance with the heat sink is R_{heatsink-ambient} [°C/W], and the ambient temperature is T_{ambient} [°C].

*Thermal resistances outside the package R_{interface (TIM)} and R_{heatsink-ambient} can be integrated into the thermal resistance R_{case-ambient} at this point. Thus, the following formula is also used:

$$T_{\text{junction}} = (R_{\text{junction-case}} + R_{\text{case-ambient}}) \cdot P_d + T_{\text{ambient}}$$